



**In the United States Patent and Trademark Office**

Serial Number: 10/713,065  
Application. Filed: November 17, 2003  
Applicant: Kia Silverbrook  
Application. Title: Laminated Support Structure for Silicon Printhead Modules  
Examiner/GAU: Julian d Huffman/2853

Dated March 22, 2005  
At: Balmain, NSW  
Docket No. ZG176US

**AMENDMENT C**

Commissioner for Patents  
Washington, District of Columbia 20231

Dear Sir:

In response to the Notice of Allowance of March 03, 2005, please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper. The Applicant submits that these amendments introduce no new matter.

**Remarks/Arguments** begin on page 3 of this paper.

E  
N  
T  
R  
Y  
A  
P  
P  
R  
O  
V  
E  
D

011

6/23/05